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This document, MC74HC4051/D has been canceled and replaced by MC74HC4051A/D LAN was sent 9/28/01

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Analog Multiplexers/ Demultiplexers High-Performance Silicon-Gate CMOS

The MC54/74HC4051, MC74HC4052 and MC54/74HC4053 utilize silicon–gate CMOS technology to achieve fast propagation delays, low ON resistances, and low OFF leakage currents. These analog multiplexers/ demultiplexers control analog voltages that may vary across the complete power supply range (from V_{CC} to V_{EE}).

The HC4051, HC4052 and HC4053 are identical in pinout to the metal–gate MC14051B, MC14052B and MC14053B. The Channel–Select inputs determine which one of the Analog Inputs/Outputs is to be connected, by means of an analog switch, to the Common Output/Input. When the Enable pin is HIGH, all analog switches are turned off.

The Channel–Select and Enable inputs are compatible with standard CMOS outputs; with pullup resistors they are compatible with LSTTL outputs.

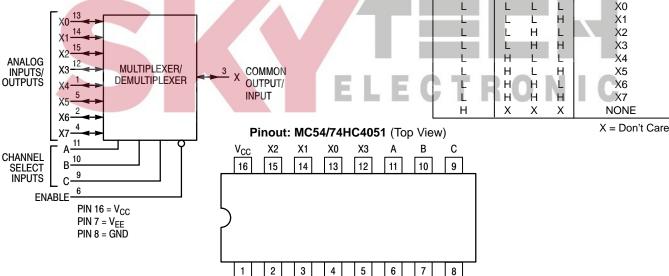
These devices have been designed so that the ON resistance (R_{on}) is more linear over input voltage than R_{on} of metal–gate CMOS analog switches.

For multiplexers/demultiplexers with channel-select latches, see HC4351, HC4352 and HC4353.

- Fast Switching and Propagation Speeds
- Low Crosstalk Between Switches
- Diode Protection on All Inputs/Outputs
- Analog Power Supply Range (V_{CC} V_{EE}) = 2.0 to 12.0 V
- Digital (Control) Power Supply Range (V_{CC} GND) = 2.0 to 6.0 V
- Improved Linearity and Lower ON Resistance Than Metal–Gate Counterparts
- Low Noise
- In Compliance With the Requirements of JEDEC Standard No. 7A
- Chip Complexity: HC4051 184 FETs or 46 Equivalent Gates
 - HC4052 168 FETs or 42 Equivalent Gates HC4053 — 156 FETs or 39 Equivalent Gates

LOGIC DIAGRAM MC54/74HC4051 Single–Pole, 8–Position Plus Common Off

Single-Pole, 8-Position Plus Common Off



X6

X4

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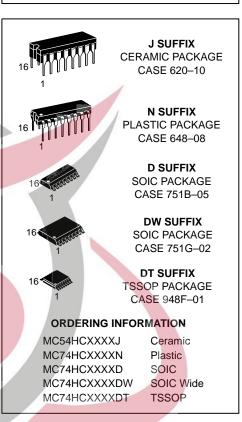
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X7

X5 Enable V_{EE}

GND

MC54/74HC4051 MC74HC4052 MC54/74HC4053



FUNCTION TABLE - MC54/74HC4051

ON Channels

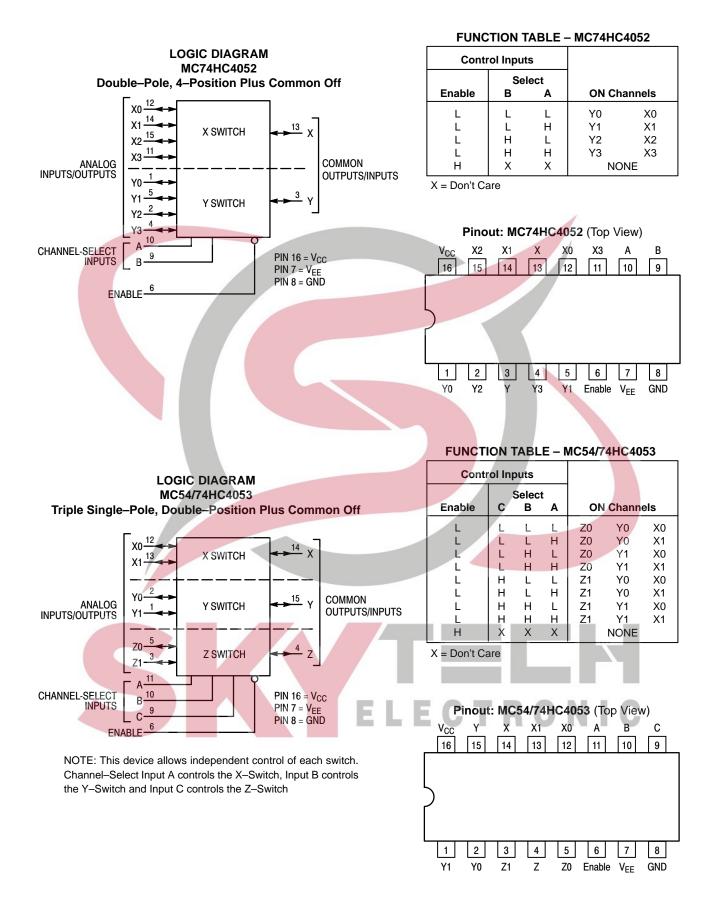
Select

B A

Control Inputs

С

Enable



MAXIMUM RATINGS*

Symbol	Parameter	Value	Unit
V _{CC}	Positive DC Supply Voltage (Referenced to GND) (Referenced to V _{EE})	- 0.5 to + 7.0 - 0.5 to + 14.0	V
V_{EE}	Negative DC Supply Voltage (Referenced to GND)	- 7.0 to + 5.0	V
V _{IS}	Analog Input Voltage	V _{EE} – 0.5 to V _{CC} + 0.5	V
V _{in}	Digital Input Voltage (Referenced to GND)	-0.5 to V _{CC} + 0.5	V
I	DC Current, Into or Out of Any Pin	± 25	mA
P _D	Power Dissipation in Still Air, Plastic or Ceramic DIP† SOIC Package† TSSOP Package†	750 500 450	mW
T _{stg}	Storage Temperature Range	– 65 to + 150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 Seconds Plastic DIP, SOIC or TSSOP Package Ceramic DIP	260 300	°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range GND $\leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$. Unused inputs must always be

tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

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* Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the Recommended Operating Conditions.

†Derating — Plastic DIP: – 10 mW/°C from 65° to 125°C Ceramic DIP: – 10 mW/°C from 100° to 125°C SOIC Package: – 7 mW/°C from 65° to 125°C

TSSOP Package: - 6.1 mW/°C from 65° to 125°C

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit	
V _{CC}	Positive DC Supply Voltage (Reference (Reference	d to GND) ed to V _{EE})	2.0 2.0	6.0 12.0	V
V _{EE}	Negative DC Supply Voltage, Output (Referen GND)	- 6.0	GND	V	
V _{IS}	Analog Input Voltage	V_{EE}	V _{CC}	V	
V _{in}	Digital Input Voltage (Referenced to GND)	GND	V _{CC}	V	
V _{IO} *	Static or Dynamic Voltage Across Switch		1.2	V	
T _A	Operating Temperature Range, All Package T	ypes	- 55	+ 125	°C
t _r , t _f	(Channel Select or Enable Inputs) V	CC = 2.0 V CC = 4.5 V CC = 6.0 V	0 0 0	1000 500 400	ns

* For voltage drops across switch greater than 1.2V (switch on), excessive V_{CC} current may be drawn; i.e., the current out of the switch may contain both V_{CC} and switch input components. The reliability of the device will be unaffected unless the Maximum Ratings are exceeded.

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			V _{CC} Guaranteed Li			imit	eed Limit	
Symbol	Parameter	Condition	V	–55 to 25°C	≤85°C	≤125°C	Unit	
V _{IH}	Minimum High–Level Input Voltage, Channel–Select or Enable Inputs	R _{on} = Per Spec	2.0 4.5 6.0	1.50 3.15 4.20	1.50 3.15 4.20	1.50 3.15 4.20	V	
V _{IL}	Maximum Low–Level Input Voltage, Channel–Select or Enable Inputs	R _{on} = Per Spec	2.0 4.5 6.0	0.3 0.9 1.2	0.3 0.9 1.2	0.3 0.9 1.2	V	
l _{in}	Maximum Input Leakage Current, Channel–Select or Enable Inputs	$V_{in} = V_{CC} \text{ or GND},$ $V_{EE} = -6.0 \text{ V}$	6.0	± 0.1	± 1.0	± 1.0	μΑ	
I _{CC}	Maximum Quiescent Supply Current (per Package)		6.0 6.0	2 8	20 80	40 160	μA	

DC CHARACTERISTICS — Digital Section (Voltages Referenced to GND) V_{EE} = GND, Except Where Noted

DC CHARACTERISTICS — Analog Section

					Guaranteed Limit			
Symbol	Parameter	Condition	Vcc	VEE	–55 to 25°C	≤85°C	≤125°C	Unit
R _{on}	Maximum "ON" Resistance		4.5 4.5 6.0	0.0 - 4.5 - 6.0	190 120 100	240 150 125	280 170 140	Ω
			4.5 4.5 6.0	0.0 - 4.5 - 6.0	150 100 80	190 125 100	230 140 115	
ΔR_{on}	Maximum Difference in "ON" Resistance Between Any Two Channels in the Same Package		4.5 4.5 6.0	0.0 - 4.5 - 6.0	30 12 10	35 15 12	40 18 14	Ω
I _{off}	Maximum Off–Channel Leakage Current, Any One Channel		6.0	- 6.0	0.1	0.5	1.0	μΑ
	Maximum Off-ChannelHC4051Leakage Current,HC4052Common ChannelHC4053	$V_{in} = V_{IL} \text{ or } V_{IH};$ $V_{IO} = V_{CC} - V_{EE};$ Switch Off (Figure 4)	6.0 6.0 6.0	- 6.0 - 6.0 - 6.0	0.2 0.1 0.1	2.0 1.0 1.0	4.0 2.0 2.0	
I _{on}	Maximum On-ChannelHC4051Leakage Current,HC4052Channel-to-ChannelHC4053		6.0 6.0 6.0	- 6.0 - 6.0 - 6.0	0.2 0.1 0.1	2.0 1.0 1.0	4.0 2.0 2.0	μΑ

			Vcc	Gu	it	Unit	
Symbol	Parameter		v	–55 to 25°C	≤85°C		≤125°C
t _{PLH} , t _{PHL}	Maximum Propagation Delay, Channel–Select to Analog Output (Figure 9)			370 74 63	465 93 79	550 110 94	ns
t _{PLH} , t _{PHL}	Maximum Propagation Delay, Analog Input to Analog Output (Figure 10)			60 12 10	75 15 13	90 18 15	ns
t _{PLZ} , t _{PHZ}	Maximum Propagation Delay, Enable to Analog Output (Figure 11)			290 58 49	364 73 62	430 86 73	ns
t _{PZL} , t _{PZH}	Maximum Propagation Delay, Enable to Analog Output (Figure 11)		2.0 4.5 6.0	345 69 59	435 87 74	515 103 87	ns
C _{in}	Maximum Input Capacitance, Char	nnel-Select or Enable Inputs		10	10	10	pF
C _{I/O}	Maximum Capacitance	Analog I/O		35	35	35	pF
	(All Switches Off)	Common O/I: HC4051 HC4052 HC4053		130 80 50	130 80 50	130 80 50	
		Feedthrough		1.0	1.0	1.0	1

AC CHARACTERISTICS ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

			Typical @ 25°C, V_{CC} = 5.0 V, V_{EE} = 0 V	
C _{PD}	Power Dissipation Capacitance (Figure 13)*	HC4051	45	pF
		HC4052	80	
		HC4053	45	

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				VEE	Limit*				
Symbol	Parameter	Condition	V _{CC} V	V	25°C			Unit	
BW	Maximum On–Channel Bandwidth or Minimum Frequency Response (Figure 6)	$f_{in} = 1$ MHz Sine Wave; Adjust f_{in} Voltage to Obtain 0dBm at V _{OS} ; Increase f_{in} Frequency Until dB Meter Reads –3dB; $R_L = 50\Omega$, $C_L = 10$ pF	2.25 4.50	-2.25 -4.50	'51 80 80	'52 95 95	'53 120 120	MHz	
	Off–Channel Feedthrough Isolation (Figure 7)	f_{in} = Sine Wave; Adjust f_{in} Voltage to Obtain 0dBm at V _{IS} f_{in} = 10kHz, R _L = 600 Ω , C _L = 50pF	6.00 2.25 4.50 6.00	-6.00 -2.25 -4.50 -6.00	80	95 50 50 50	120	dB	
		$f_{in} = 1.0MHz, R_L = 50\Omega, C_L = 10pF$	2.25 4.50 6.00	-2.25 -4.50 -6.00	1	-40 -40 -40			
_	Feedthrough Noise. Channel–Select Input to Common I/O (Figure 8)	$ \begin{array}{l} V_{in} \leq 1 MHz \; Square \; Wave \; (t_r = t_f = 6ns); \\ \text{Adjust } R_L \; at \; Setup \; so \; that \; I_S = 0A; \\ \text{Enable} = GND \qquad \qquad R_L = 600\Omega, \; C_L = 50 pF \end{array} $	2.25 4.50 6.00	-2.25 -4.50 -6.00		25 105 135		mV _{PP}	
		R _L = 10kΩ, C _L = 10pF	2.25 4.50 6.00	-2.25 -4.50 -6.00		35 145 190			
_	Crosstalk Between Any Two Switches (Figure 12) (Test does not apply to HC4051)		2.25 4.50 6.00	-2.25 -4.50 -6.00		-50 -50 -50		dB	
		f _{in} = 1.0MHz, R _L = 50Ω, C _L = 10pF	2.25 4.50 6.00	-2.25 -4.50 -6.00		-60 -60 -60			
THD	Total Harmonic Distortion (Figure 14)	$\label{eq:states} \begin{array}{l} f_{in} = 1 \text{kHz}, \text{R}_L = 10 \text{k}\Omega, \text{C}_L = 50 \text{pF} \\ \text{THD} = \text{THD}_{measured} - \text{THD}_{source} \\ \text{V}_{IS} = 4.0 \text{V}_{PP} \text{sine wave} \\ \text{V}_{IS} = 8.0 \text{V}_{PP} \text{sine wave} \\ \text{V}_{IS} = 11.0 \text{V}_{PP} \text{sine wave} \end{array}$	2.25 4.50 6.00	-2.25 -4.50 -6.00		0.10 0.08 0.05		%	

ADDITIONAL APPLICATION CHARACTERISTICS (GND = 0 V)

* Limits not tested. Determined by design and verified by qualification.

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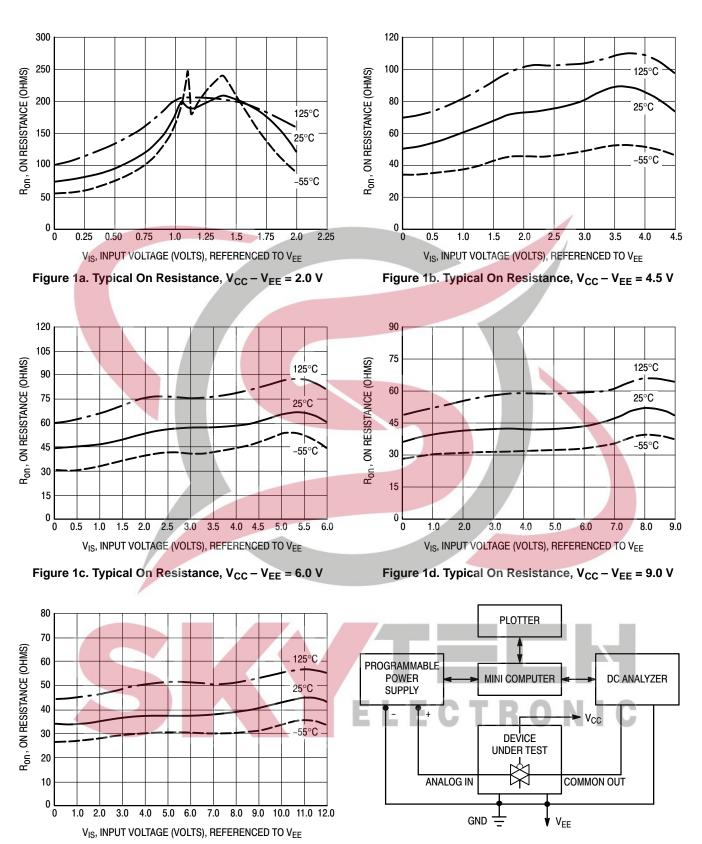


Figure 1e. Typical On Resistance, V_{CC} – V_{EE} = 12.0 V

Figure 2. On Resistance Test Set–Up

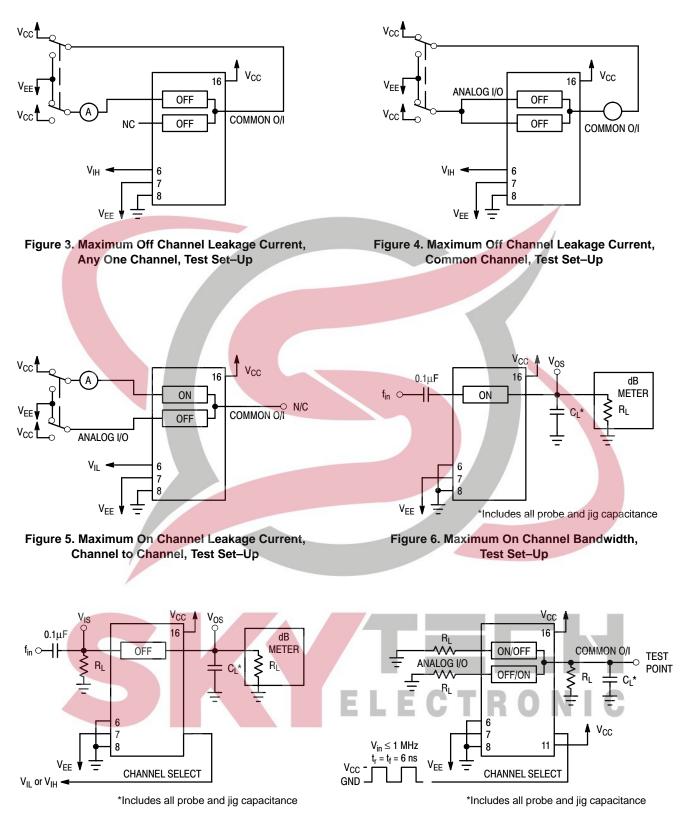
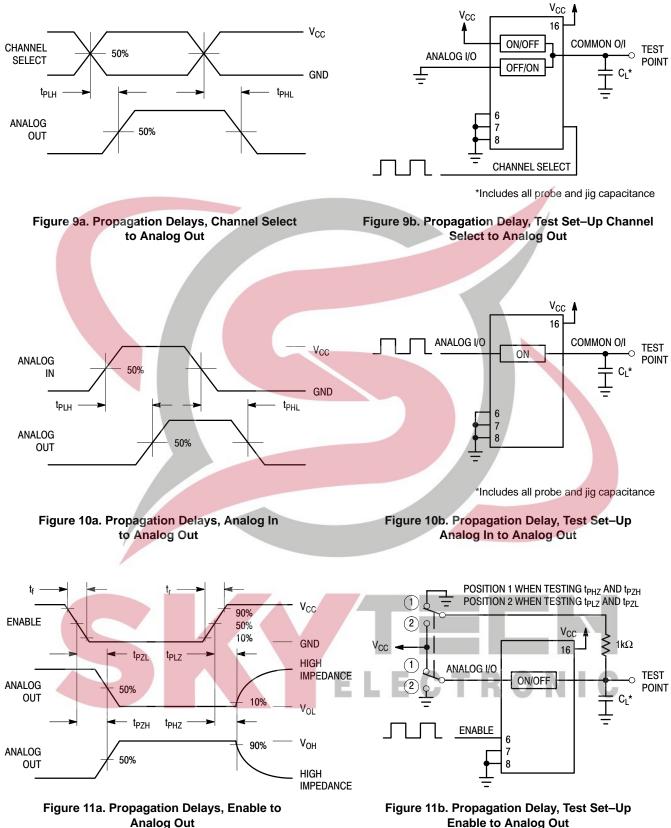
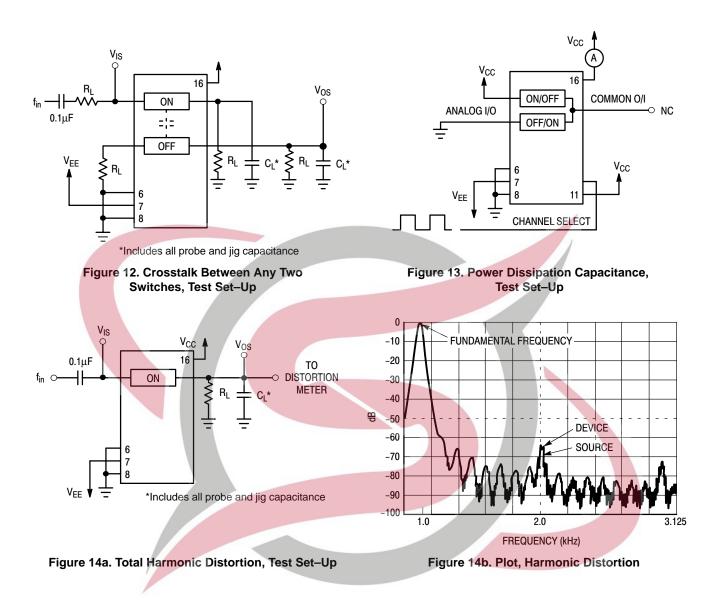


Figure 7. Off Channel Feedthrough Isolation, Test Set–Up Figure 8. Feedthrough Noise, Channel Select to

Common Out, Test Set–Up



Enable to Analog Out



APPLICATIONS INFORMATION

The Channel Select and Enable control pins should be at V_{CC} or GND logic levels. V_{CC} being recognized as a logic high and GND being recognized as a logic low. In this example:

$$V_{CC} = +5V = logic high$$

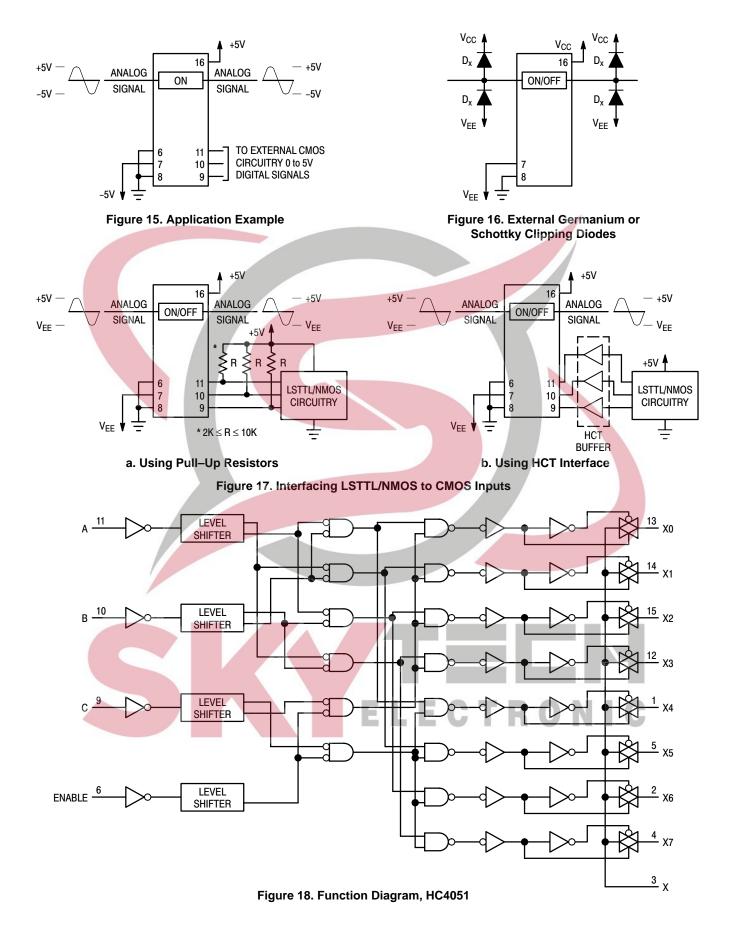
GND = 0V = logic low

The maximum analog voltage swings are determined by the supply voltages V_{CC} and V_{EE} . The positive peak analog voltage should not exceed V_{CC} . Similarly, the negative peak analog voltage should not go below V_{EE} . In this example, the difference between V_{CC} and V_{EE} is ten volts. Therefore, using the configuration of Figure 15, a maximum analog signal of ten volts peak-to-peak can be controlled. Unused analog inputs/outputs may be left floating (i.e., not connected). However, tying unused analog inputs and outputs to V_{CC} or GND through a low value resistor helps minimize crosstalk and feedthrough noise that may be picked up by an unused switch.

Although used here, balanced supplies are not a requirement. The only constraints on the power supplies are that:

$$\begin{array}{l} V_{CC}-GND=2 \text{ to } 6 \text{ volts} \\ V_{EE}-GND=0 \text{ to } -6 \text{ volts} \\ V_{CC}-V_{EE}=2 \text{ to } 12 \text{ volts} \\ \text{ and } V_{EE} \leq GND \end{array}$$

When voltage transients above V_{CC} and/or below V_{EE} are anticipated on the analog channels, external Germanium or Schottky diodes (D_x) are recommended as shown in Figure 16. These diodes should be able to absorb the maximum anticipated current surges during clipping.



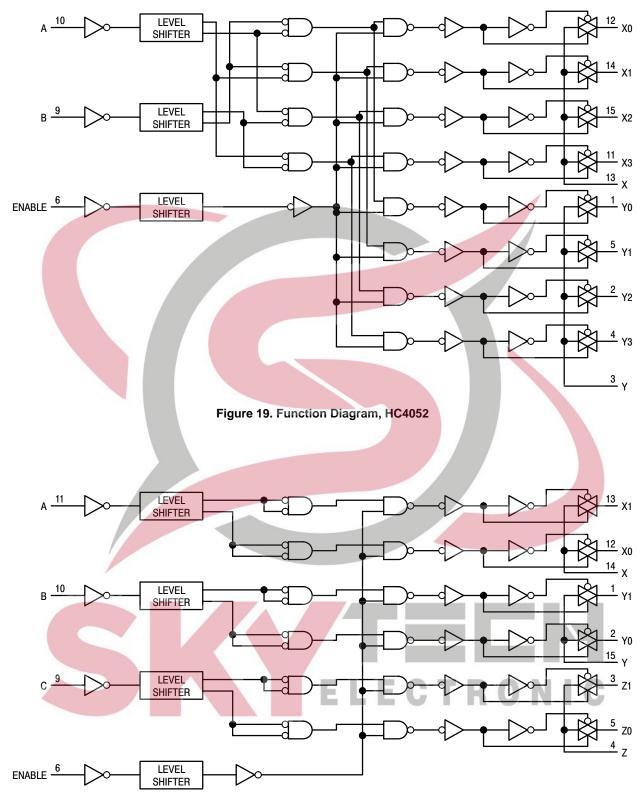
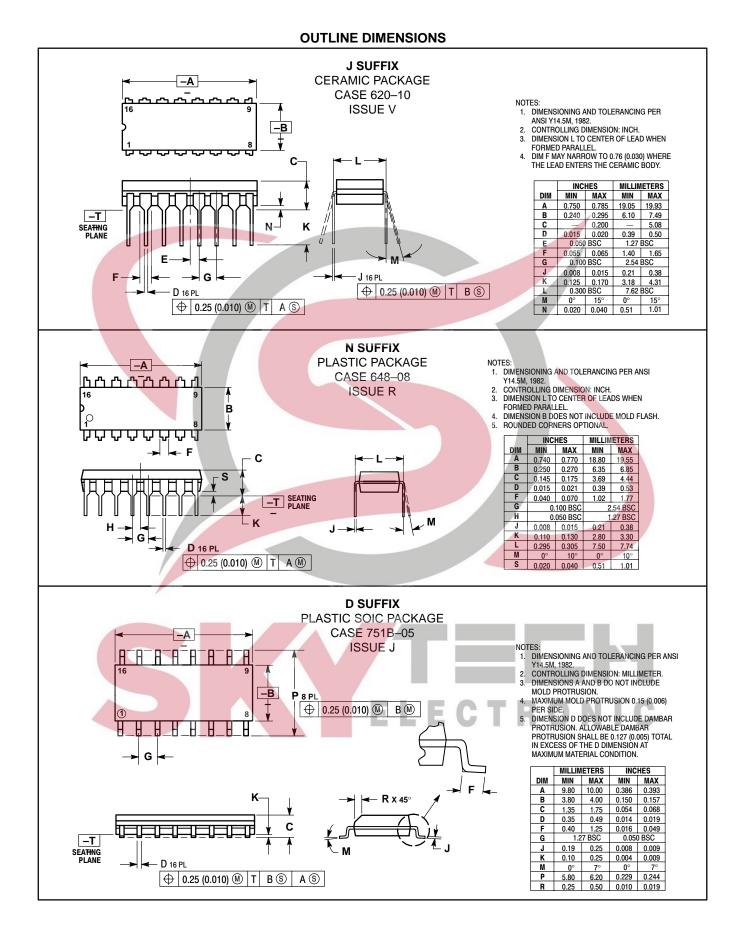
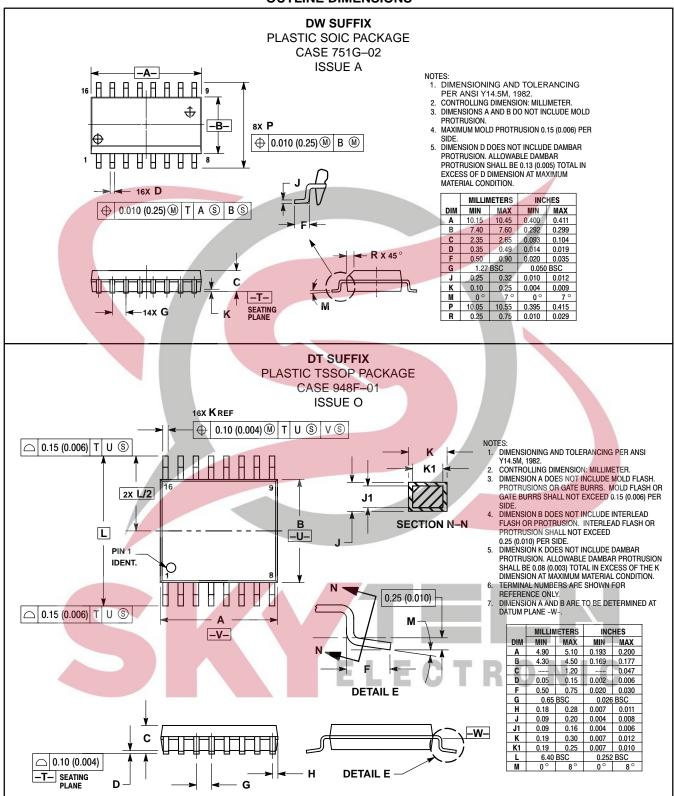


Figure 20. Function Diagram, HC4053



OUTLINE DIMENSIONS





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